

Vishay Siliconix

N-Channel 55 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^a		
55	0.0200 at V _{GS} = 10 V	35		
	0.0260 at V _{GS} = 4.5 V	30		

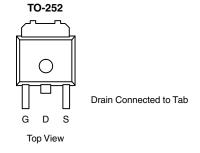
FEATURES

- TrenchFET® Power MOSFETS
- 175 °C Rated Maximum Junction Temperature

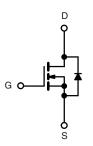
Low Input Capacitance

COMPLIANT

Material categorization: For definitions of compliance please see www.vishay.com/doc?99912



Ordering Information: SUD35N05-26L-E3 (Lead (Pb)-free)



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $(T_A =$	25 °C, unless othe	rwise noted)			
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	55	V	
Gate-Source Voltage		V _{GS}	± 20	- V	
Continuous Dunin Compant /T 175 96\h	T _C = 25 °C		35		
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 100 °C	I _D	25	_	
Pulsed Drain Current		I _{DM}	80	A	
Continuous Source Current (Diode Conduction) ^a	I _S	35			
Manifesture Danier Dissipation	T _C = 25 °C	В	50 ^c	14/	
Maximum Power Dissipation	T _A = 25 °C	P _D	7.5 ^b	- w	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Junction-to-Ambient ^b	t ≤ 10 s	- R _{thJA}	17	20	0000		
Junction-to-Ambient	Steady State		50	60			
Junction-to-Case	R _{thJC}	2.5	3	°C/W			
Junction-to-Lead	R _{thJL}	5	6				

- a. Package limited.
- b. Surface mounted on 1" x1" FR4 board, $t \le 10$ s.
- c. See SOA curve for voltage derating.

^{*} Pb containing terminations are not RoHS compliant, exemptions may apply.

SUD35N05-26L

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SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)							
Parameter	Symbol	Test Conditions	Min.	Typ ^a	Max.	Unit	
Static				•			
Drain-Source Breakdown Voltage	V_{BR}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	55		V		
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	1			V	
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Cuvvant	1	V _{DS} = 44 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 44 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 5 V	35			Α	
		V _{GS} = 10 V, I _D = 20 A		0.0165	0.0200	Ω	
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 10 A, T _J = 125 °C			0.0350		
		$V_{GS} = 4.5 \text{ V}, I_D = 15 \text{ A}$		0.0215	0.0260		
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 20 A		25		S	
Dynamic ^a				•			
Input Capacitance	C _{iss}			885		pF	
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		185			
Reverse Transfer Capacitance	C _{rss}			80			
Total Gate Charge ^c	Q_g			10.5	13		
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 25 \text{ V}, V_{GS} = 5 \text{ V}, I_{D} = 35 \text{ A}$		4		nC	
Gate-Drain Charge ^c	Q_{gd}			4.8		1	
Turn-On Delay Time ^c	t _{d(on)}			5	8		
Rise Time ^c	t _r	$V_{DD} = 25 \text{ V}, R_{L} = 0.3 \Omega$		18	30		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 35 \text{ A}, V_{GEN} = 10 \text{ V}, R_G = 2.5 \Omega$		20	30	ns	
Fall Time ^c	t _f			100	150		
Source-Drain Diode Ratings and Cha	racteristic (T	_C = 25 °C)					
Continuous Current	I _S				35	А	
Pulsed Current	I _{SM}	SM			80		
Diode Forward Voltage ^b	V_{SD}	$I_F = 80 \text{ A}, V_{GS} = 0 \text{ V}$			1.5	V	
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 35 A, di/dt = 100 A/μs		25	40	ns	

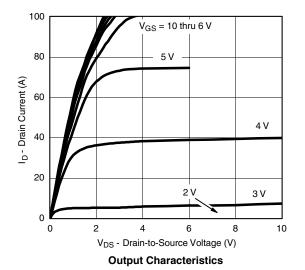
Notes:

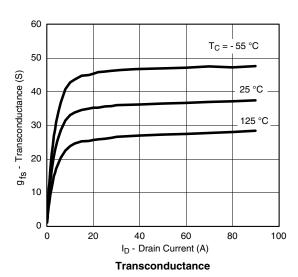
- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. Independent of operating temperature.

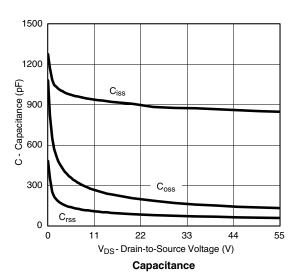
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

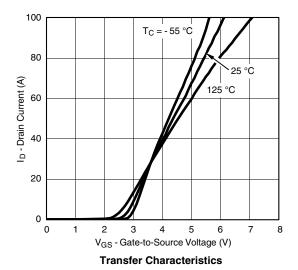


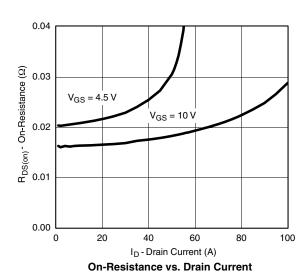
TYPICAL CHARACTERISTICS (25 °C unless noted)

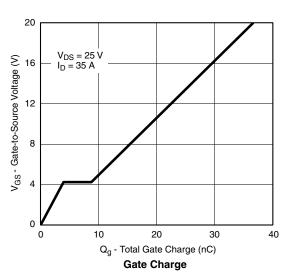






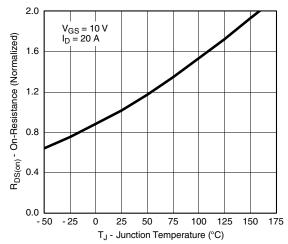






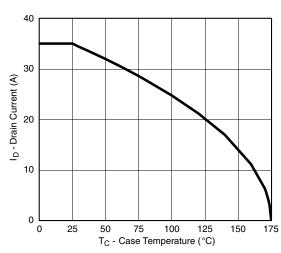
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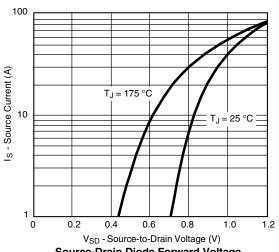


On-Resistance vs. Junction Temperature

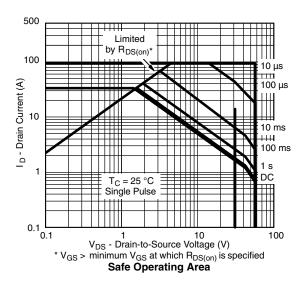
THERMAL RATINGS



Max. Avalanche and Drain Current vs. Case Temperature



Source-Drain Diode Forward Voltage



2 Duty Cycle = 0.5 Normalized Effective Transient Thermal Impedance 0.2 0.1 ngle Pulse 0.01 10⁻³ . 10⁻⁴ 10-2 10⁻¹ 10 30 Square Wave Pulse Duration (s)

Normalized Thermal Transient Impedance, Junction-to-Case

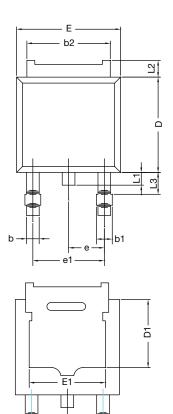
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?71443.

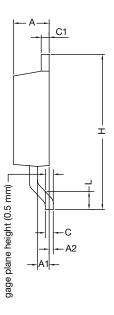
Document Number: 71443 S12-1360-Rev. C, 11-Jun-12 For more information please contact: pmostechsupport@vishay.com



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TO-252AA CASE OUTLINE





	MILLIMETERS		INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	2.21	2.38	0.087	0.094	
A1	0.89	1.14	0.035	0.045	
A2	0.030	0.127	0.001	0.005	
b	0.71	0.88	0.028	0.035	
b1	0.76	1.14	0.030	0.045	
b2	5.23	5.44	0.206	0.214	
С	0.46	0.58	0.018	0.023	
C1	0.46	0.58	0.018	0.023	
D	5.97	6.22	0.235	0.245	
D1	4.10	4.45	0.161	0.175	
Е	6.48	6.73	0.255	0.265	
E1	4.49	5.50	0.177	0.217	
е	2.28	2.28 BSC		BSC	
e1	4.57 BSC		0.180	BSC	
Η	9.65	10.41	0.380	0.410	
L	1.40	1.78	0.055	0.070	
L1	0.64	1.02	0.025	0.040	
L2	0.89	1.27	0.035	0.050	
L3	1.15	1.52	0.040	0.060	
ECN: T11-0110-Rev. L, 18-Apr-11 DWG: 5347					

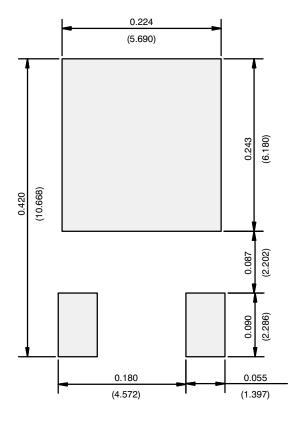
Note

• Dimension L3 is for reference only.

Document Number: 71197 www.vishay.com



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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